Form PTO-1449 (REV 8-83)	DEPARTMENT OF COMMERCE PATENT AND TRADEMARK OFFICE	SERIAL NO. Herewith	ATTY DOCKET NO. STL 11004.00		
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INFORMATION DISCLOSURE CITATION		Ed F. Rejda et al.			
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	(OOD	PAGE 1 OF 1		Herewith		Not Yet Assi	gned	
				TT DOCUMENTS	OT ASS	SUBCLASS	FILING	
E.I.		DOCUMENT NUMBER	DATE	NAME	CLASS	<u> </u>	DATE	
M	AA	4,549,238	10/22/85	Ertingshausen, et al	360	103	1/10/83	
T	AB	5,118,577	6/2/92	Brar et al	428	409	7/3/89	
-2-	AC	6,027,660	2/22/00	Hsiao et al	216	22	5/11/98	
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	AF	6,252,741 B1	6/26/01	Ahn, Junghi	360	235.1	5/11/99	
	AG	6,199,267	3/13/01	Koshikawa et al	29	603.15	3/31/99	
	АН	5,916,423	6/29/99	Westwood, John David	204	192.32	5/6/97	
	AI	6,063,244	5/16/00	Pinarbasi, Mustafa	204	192.11	5/21/98	
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T	AL	6,170,149	1/9/01	Oshiki et al	29	603.09	1/30/97	
/~~	AM	5,903,968	5/18/99	Shouji, Shigeru	29	603.09	3/23/95	
<u> </u>	AN							
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	AP							
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			FOREIGN PA	TENT DOCUMENTS				
E.I.		DOCUMENT NUMBER	DATE	COUNTRY	CLASS	SUBCLASS	TRANS- LATION	
	AS							
		OTHER DOCUMENTS (INC	LUDING AUT	HOR, TITLE, DATE, PERTINEN	T PAGES, E1	C.)	estion:	
pu	AT	Diane K. Stewart, J. David Casey, Jr., <u>Handbook of Microlithography</u> , <u>Micromachining</u> , and <u>Microfabrication</u> ; <u>Volume 2: Micromachining and Microfabrication</u> , Ch. 4, 153·195 (1999)						
m	AU	P.E. Russell, T.J. Stark, D.P. Griffis, J.R. Phillips, and K.F. Jarausch, Chemically and Geometrically Enhanced Focused Ion Beam Micromachining, J. Vac. Sci. Technol. B 16(4), 2494-2498 (Jul/Aug 1998)						
EXAM	INER	Jodnas Miller	1	DATE CONSIDERED	19/0			

EXAMINER: Initial if reference considered, whether or not citation is in conformance with MPEP 609; draw line through citation if not in conformance and not considered. Include copy of this form with next communication to the applicant.